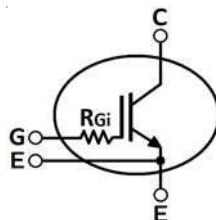


**XPT™ 650V IGBT**  
**GenX4™**
**IXXN200N65A4**

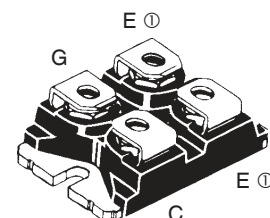
 Extreme Light Punch Through  
 IGBT for 5-20kHz Switching


$$V_{CES} = 650V$$

$$I_{C110} = 200A$$

$$V_{CE(sat)} \leq 1.80V$$

$$t_{fi(typ)} = 123ns$$

 SOT-227B, miniBLOC  
 E153432

 G = Gate, C = Collector, E = Emitter  
 Ⓢ either emitter terminal can be used as  
 Main or Kelvin Emitter

| Symbol                        | Test Conditions  | Maximum Ratings                           |                        |
|-------------------------------|--|---|------------------------|
| $V_{CES}$                     | $T_J = 25^\circ C$ to $175^\circ C$  | 650                                       | V                      |
| $V_{CGR}$                     | $T_J = 25^\circ C$ to $175^\circ C$ , $R_{GE} = 1M\Omega$                                  | 650                                       | V                      |
| $V_{GES}$                     | Continuous   | $\pm 20$                                  | V                      |
| $V_{GEM}$                     | Transient  | $\pm 30$                                  | V                      |
| $I_{C25}$                     | $T_C = 25^\circ C$ (Chip Capability)   | 410                                       | A                      |
| $I_{LRMS}$                    | Leads Current Limit  | 200                                       | A                      |
| $I_{C110}$                    | $T_C = 110^\circ C$  | 200                                       | A                      |
| $I_{CM}$                      | $T_C = 25^\circ C$ , 1ms   | 1200                                      | A                      |
| <b>SSOA</b><br><b>(RBSOA)</b> | $V_{GE} = 15V$ , $T_{VJ} = 150^\circ C$ , $R_G = 2\Omega$<br>Clamped Inductive Load        | $I_{CM} = 400$<br>$@ V_{CE} \leq V_{CES}$ | A                      |
| $t_{sc}$<br><b>(SCSOA)</b>    | $V_{GE} = 15V$ , $V_{CE} = 360V$ , $T_J = 150^\circ C$<br>$R_G = 2\Omega$ , Non Repetitive | 10  | $\mu s$                |
| $P_C$                         | $T_C = 25^\circ C$   | 1250                                      | W                      |
| $T_J$                         |  | -55 ... +175                              | $^\circ C$             |
| $T_{JM}$                      |  | 175                                       | $^\circ C$             |
| $T_{stg}$                     |  | -55 ... +175                              | $^\circ C$             |
| $V_{ISOL}$                    | 50/60Hz<br>$I_{ISOL} \leq 1mA$   | $t = 1min$<br>$t = 1s$                    | 2500 V~<br>3000 V~     |
| $M_d$                         | Mounting Torque<br>Terminal Connection Torque  | 1.5/13<br>1.3/11.5                        | Nm/lb.in.<br>Nm/lb.in. |
| <b>Weight</b>                 |  | 30  | g                      |

**Features**

- Optimized for Low Conduction and Switching Losses
- miniBLOC, with Aluminium Nitride Isolation
- International Standard Package
- Isolation Voltage 2500V~
- Optimized for 5-20kHz Switching
- Square RBSOA
- Short Circuit Capability
- High Current Handling Capability
- Easy to Parallel

**Advantages**

- High Power Density
- Low Gate Drive Requirement

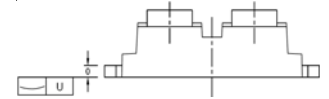
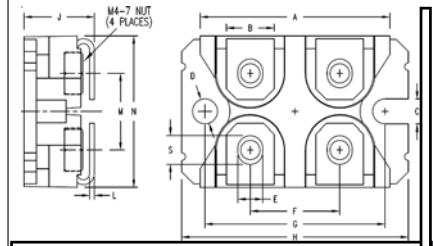
**Applications**

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines

| Symbol        | Test Conditions<br>( $T_J = 25^\circ C$ , Unless Otherwise Specified) | Characteristic Values |              |                           |
|---------------|---|-----------------------|--------------|---------------------------|
|               |   | Min.                  | Typ.         | Max.                      |
| $BV_{CES}$    | $I_C = 4mA$ , $V_{GE} = 0V$   | 650                   |              | V                         |
| $V_{GE(th)}$  | $I_C = 3mA$ , $V_{CE} = V_{GE}$                                       | 5.0                   |              | 6.5 V                     |
| $I_{CES}$     | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 150^\circ C$             |                       |              | 10 $\mu A$<br>500 $\mu A$ |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                    |                       |              | $\pm 200$ nA              |
| $V_{CE(sat)}$ | $I_C = 150A$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 150^\circ C$         |                       | 1.44<br>1.15 | V<br>V                    |

| Symbol Test Conditions<br>( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified) |  | Characteristic Values |      |                         |
|--|--|-----------------------|------|-------------------------|
|  |  | Min.                  | Typ. | Max.                    |
| $g_{fs}$   | $I_C = 60\text{A}, V_{CE} = 10\text{V}$ , Note 1   | 48                    | 80   | S                       |
| $C_{ies}$  | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$   |                       | 7400 | pF                      |
| $C_{oes}$  |  |                       | 526  | pF                      |
| $C_{res}$  |  |                       | 370  | pF                      |
| $R_{Gi}$   | Integrated Gate Resistor   |                       | 4    | $\Omega$                |
| $Q_g$  | $I_C = 200\text{A}, V_{GE} = \pm 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$   |                       | 930  | nC                      |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = 100\text{A}, V_{GE} = \pm 15\text{V}$<br>$V_{CE} = 300\text{V}, R_G = 2\Omega$<br>Note 2  |                       | 260  | ns                      |
| $t_{ri}$   |  |                       | 120  | ns                      |
| $E_{on}$   |  |                       | 4.4  | mJ                      |
| $t_{d(off)}$   |  |                       | 540  | ns                      |
| $t_{fi}$   |  |                       | 123  | ns                      |
| $E_{off}$  |  |                       | 4.6  | mJ                      |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 150^\circ\text{C}</math></b><br>$I_C = 100\text{A}, V_{GE} = \pm 15\text{V}$<br>$V_{CE} = 300\text{V}, R_G = 2\Omega$<br>Note 2 |                       | 170  | ns                      |
| $t_{ri}$   |  |                       | 144  | ns                      |
| $E_{on}$   |  |                       | 6.1  | mJ                      |
| $t_{d(off)}$   |  |                       | 420  | ns                      |
| $t_{fi}$   |  |                       | 290  | ns                      |
| $E_{off}$  |  |                       | 6.7  | mJ                      |
| $R_{thJC}$   |  |                       |      | 0.12 $^\circ\text{C/W}$ |
| $R_{thCS}$   |  | 0.05                  |      | $^\circ\text{C/W}$      |

### SOT-227B miniBLOC (IXXN)



| SYM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | 1.224  | 1.260 | 31.10       | 32.00 |
| B   | .303   | .327  | 7.70        | 8.30  |
| C   | .161   | .173  | 4.10        | 4.40  |
| D   | .161   | .173  | 4.10        | 4.40  |
| E   | .161   | .173  | 4.10        | 4.40  |
| F   | .587   | .598  | 14.90       | 15.20 |
| G   | 1.181  | 1.201 | 30.00       | 30.50 |
| H   | 1.488  | 1.508 | 37.80       | 38.30 |
| J   | .461   | .484  | 11.70       | 12.30 |
| L   | .030   | .033  | 0.75        | 0.85  |
| M   | .492   | .512  | 12.50       | 13.00 |
| N   | .984   | 1.004 | 25.00       | 25.50 |
| O   | .075   | .087  | 1.90        | 2.20  |
| S   | .181   | .193  | 4.60        | 4.90  |
| U   | .000   | .005  | 0.00        | 0.13  |

#### Notes:

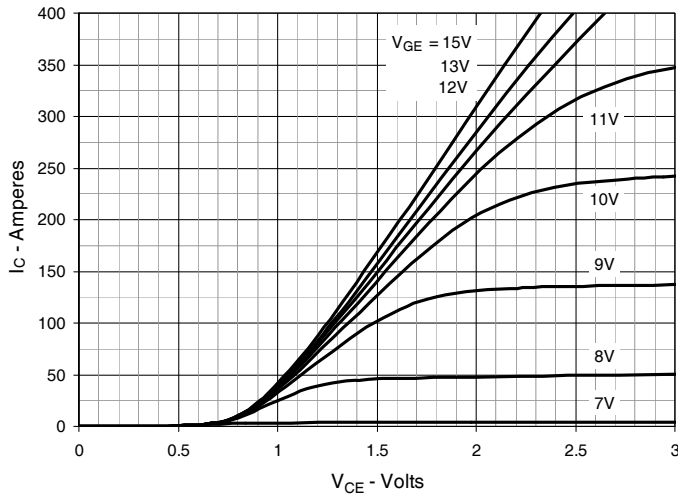
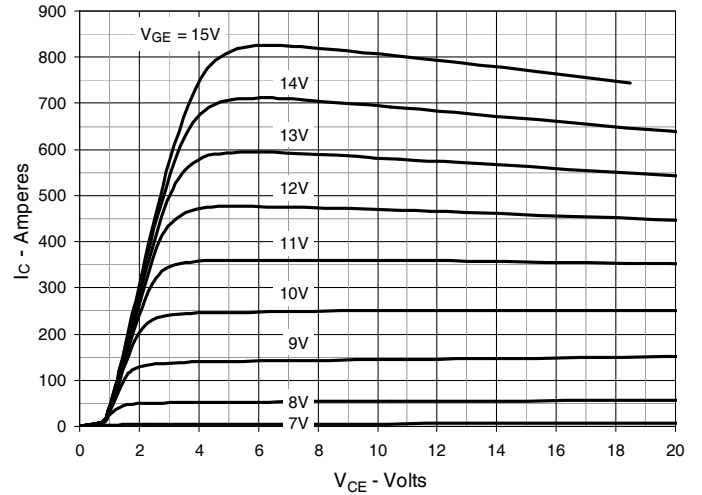
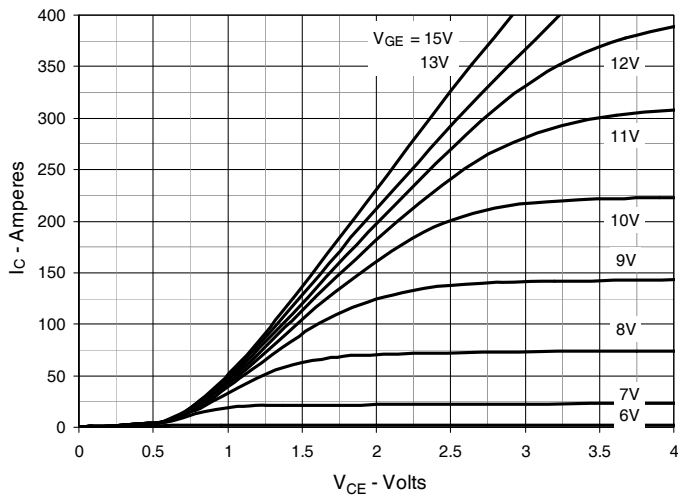
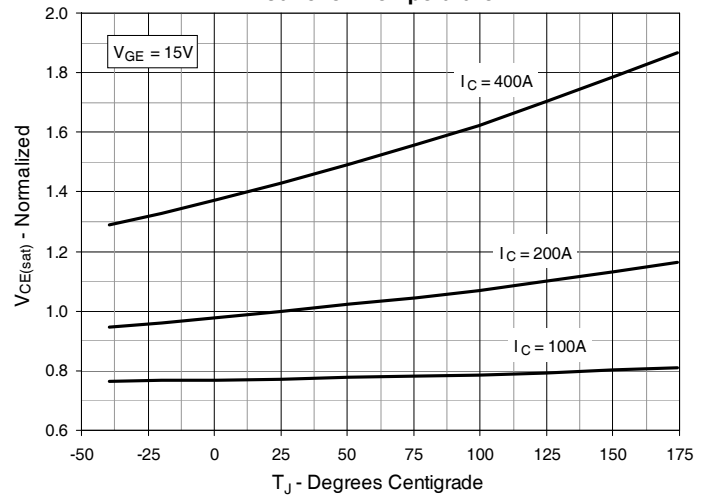
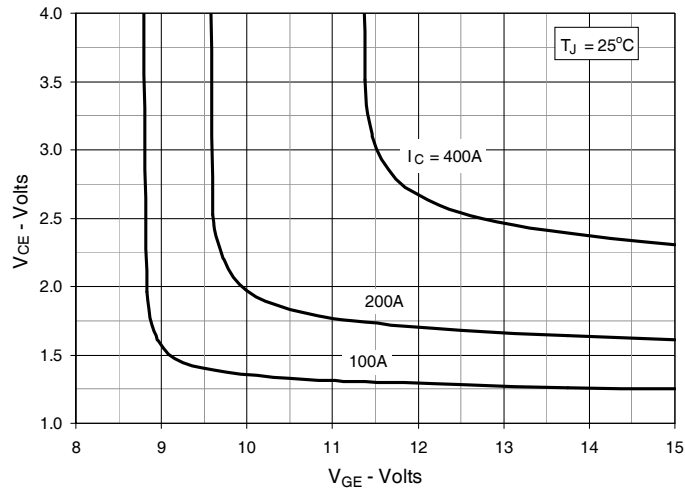
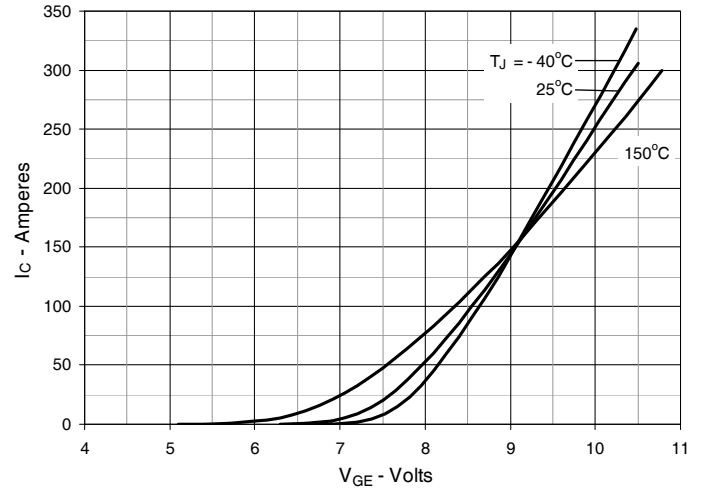
1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .
2. Switching times & energy losses may increase for higher  $V_{CE}$  (clamp),  $T_J$  or  $R_G$ .

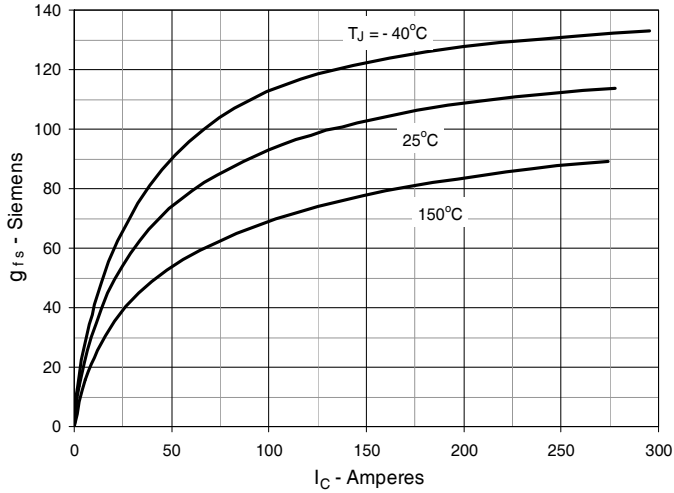
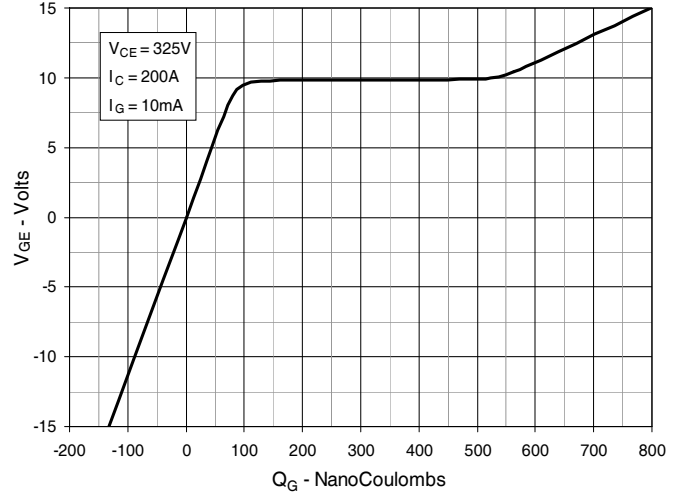
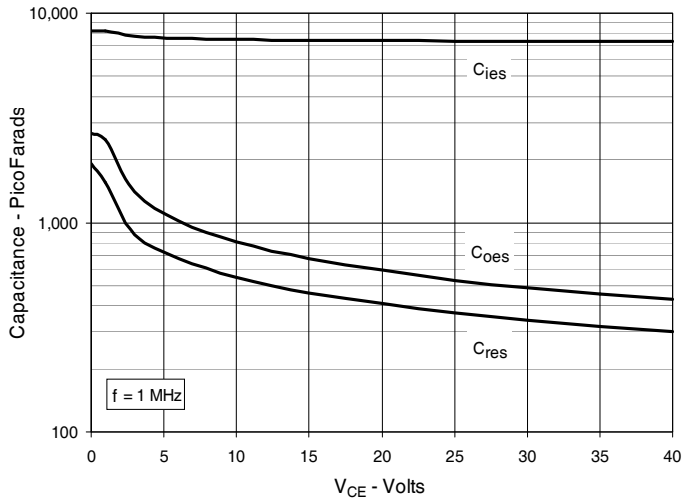
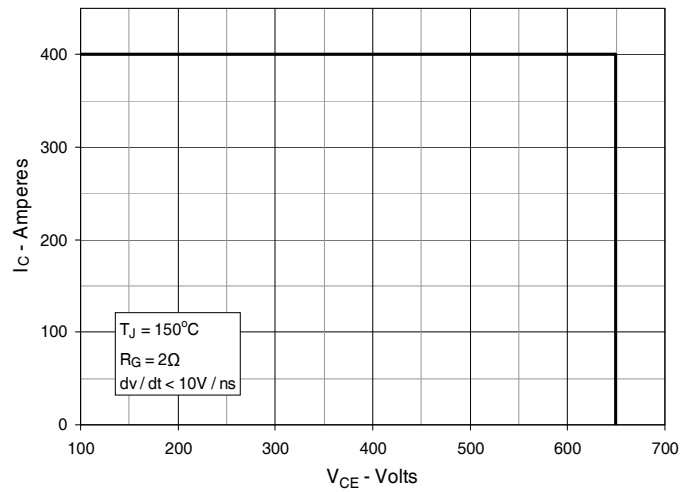
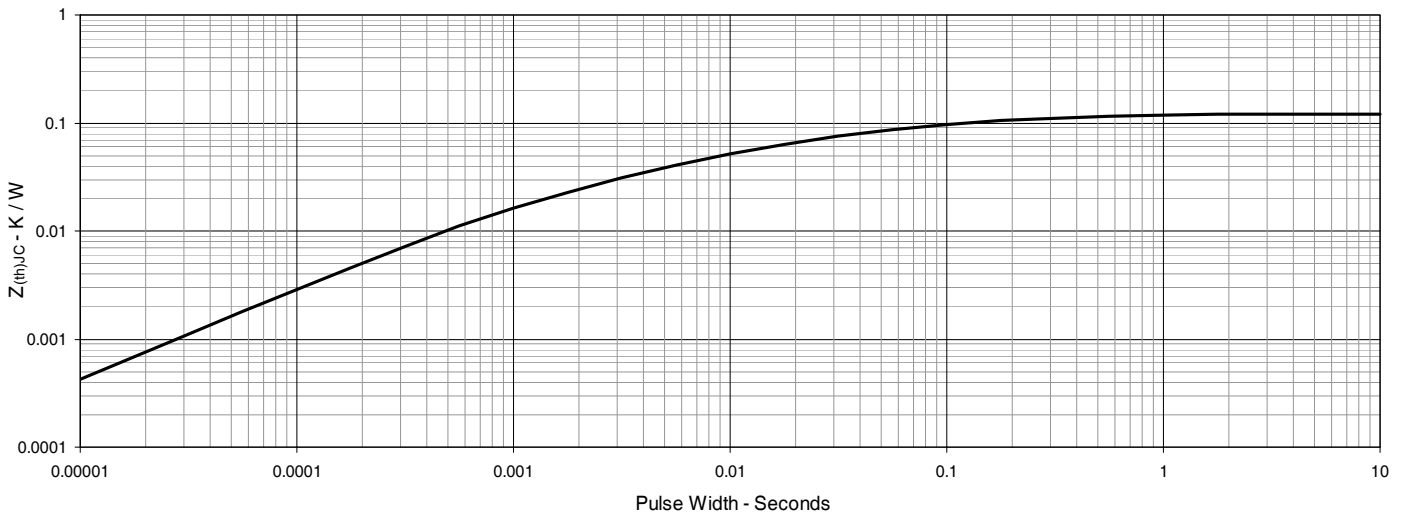
### PRELIMINARY TECHNICAL INFORMATION

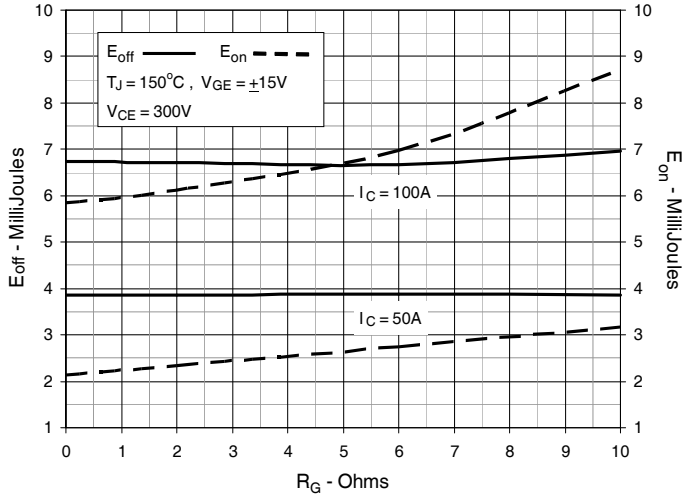
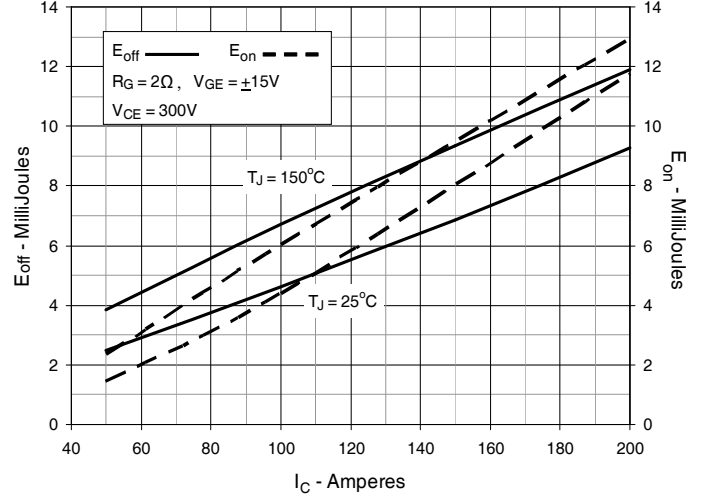
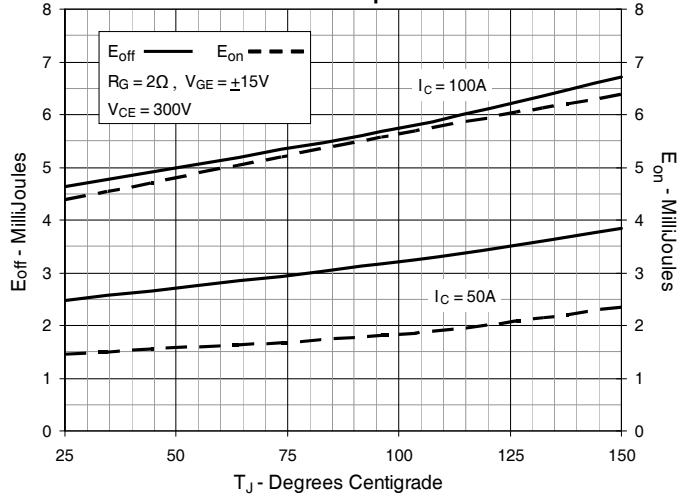
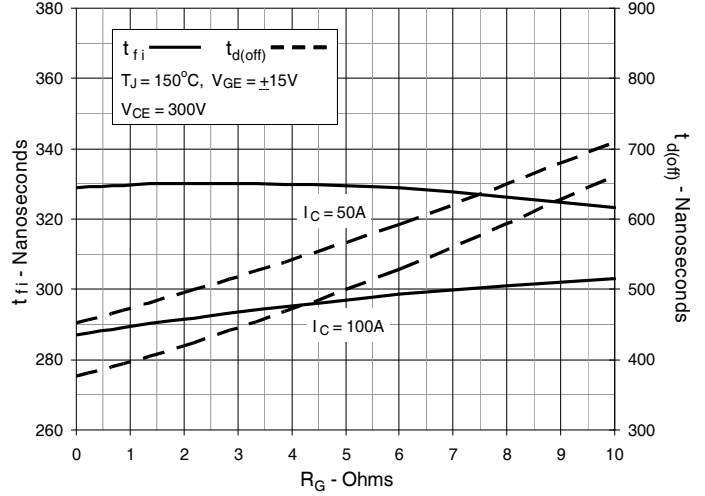
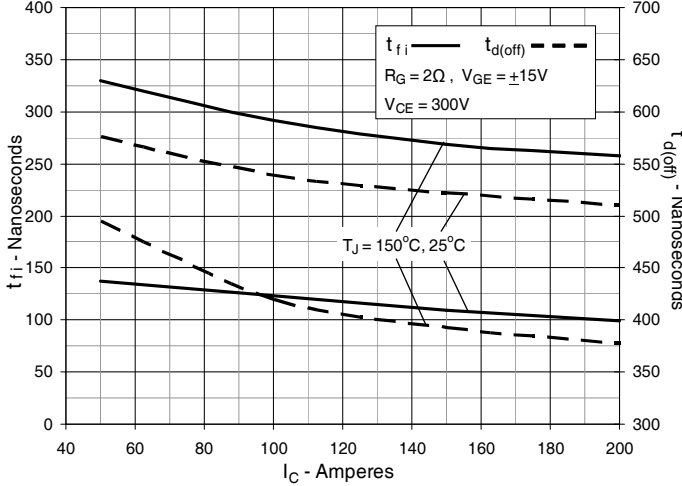
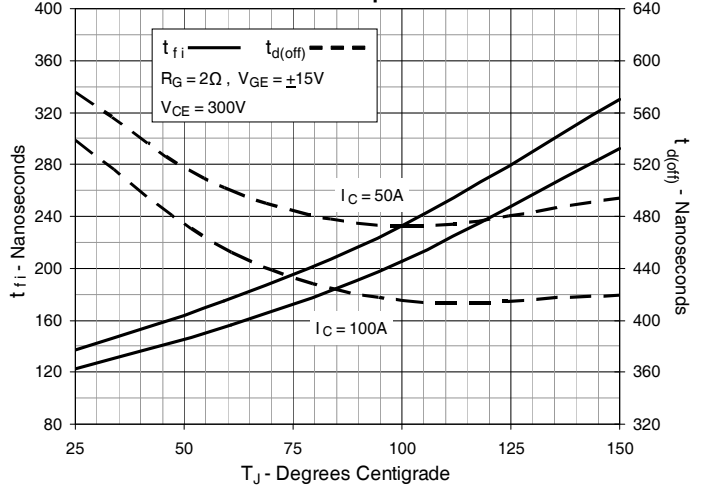
The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

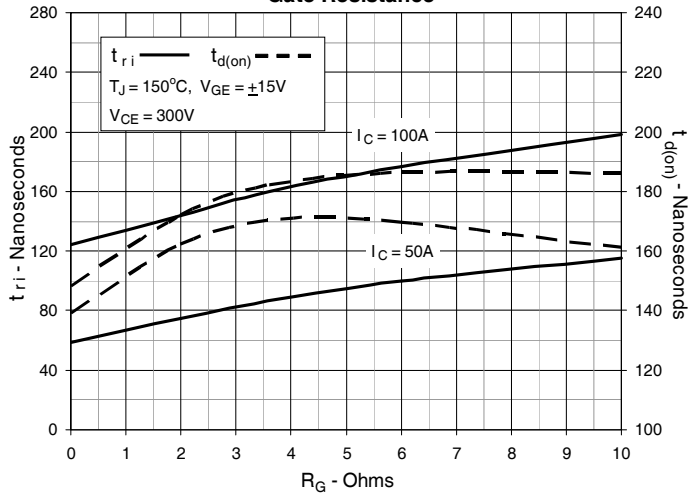
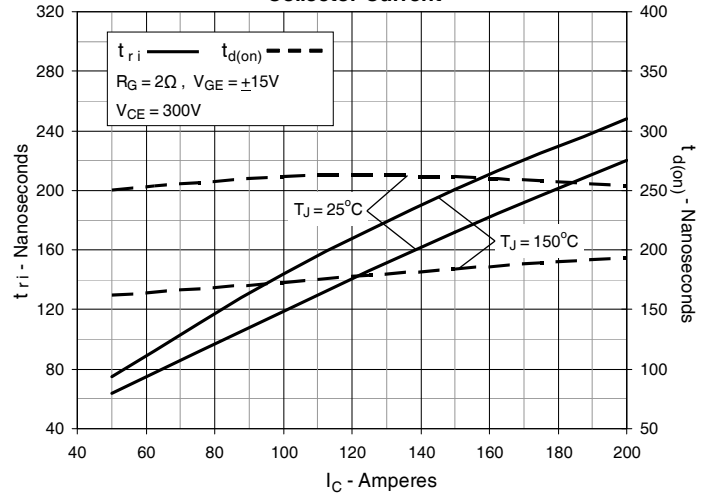
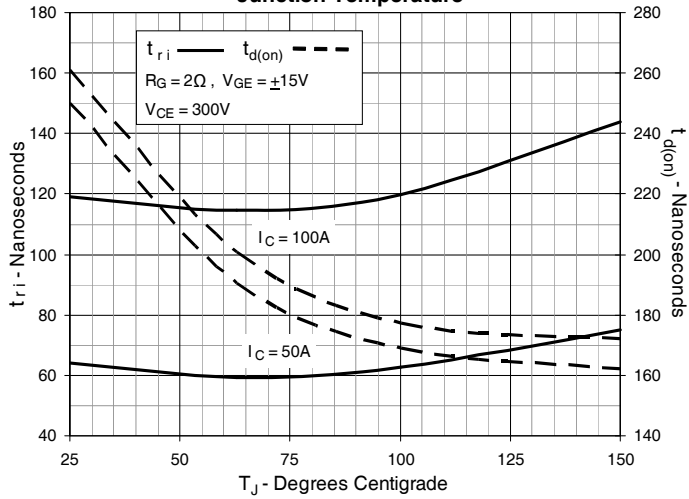
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IXYS MOSFETs and IGBTs are covered 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2  
by one or more of the following U.S. patents: 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2  
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 3. Output Characteristics @  $T_J = 150^\circ\text{C}$** 

**Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature**

**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**

**Fig. 6. Input Admittance**


**Fig. 7. Transconductance**

**Fig. 8. Gate Charge**

**Fig. 9. Capacitance**

**Fig. 10. Reverse-Bias Safe Operating Area**

**Fig. 11. Maximum Transient Thermal Impedance**


**Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance**

**Fig. 13. Inductive Switching Energy Loss vs. Collector Current**

**Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature**

**Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance**

**Fig. 16. Inductive Turn-off Switching Times vs. Collector Current**

**Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature**


**Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance**

**Fig. 19. Inductive Turn-on Switching Times vs. Collector Current**

**Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature**




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